

Title (en)

CADMIUM-FREE ZINC-BASED ALLOY, ITS USE AS A SACRIFICIAL ANODE, A SACRIFICIAL ANODE, AND A METHOD FOR CATHODIC PROTECTION OF CORROSION-THREATENED CONSTRUCTIONS IN AGGRESSIVE ENVIRONMENT

Title (de)

CADMIUMFREIE ZINKLEGIERUNG, IHRE VERWENDUNG ALS OPFERANODE, OPFERANODE UND VERFAHREN ZUM KATHODISCHEN SCHUTZ VON KORROSIONSGEFÄHRDETEN KONSTRUKTIONEN IN AGGRESSIVER UMGEBUNG

Title (fr)

ALLIAGE À BASE DE ZINC SANS CADMIUM, SON UTILISATION EN TANT QU ANODE RÉACTIVE, ANODE RÉACTIVE, ET PROCÉDÉ POUR LA PROTECTION CATHODIQUE DE CONSTRUCTIONS PRÉSENTANT UN RISQUE DE CORROSION DANS UN ENVIRONNEMENT AGRESSIF

Publication

**EP 2276866 A1 20110126 (EN)**

Application

**EP 09724942 A 20090325**

Priority

- IB 2009051239 W 20090325
- DK PA200800453 A 20080328
- US 4201308 P 20080403

Abstract (en)

[origin: WO2009118693A1] A cadmium-free, zinc-based alloy suitable as a sacrificial anode substantially consists of 0.4- 0 6% by weight of aluminum, 0.02-0.03% by weight of indium, max, 0.001% by weight of cadmium, maximum 0.005% by weight of copper, maximum 0.006% by weight of lead, maximum 0.0005% by weight of tin, maximum 0.10% by weight of other metals, in particular nickel and thallium, and balance zinc having a purity of about 99.995% The alloy shows advantageous properties with respect to resistance to cracking and breaking during post machining of the casting, especially when producing sacrificial anodes having relatively small dimensions.

IPC 8 full level

**C22C 18/04** (2006.01); **C23F 13/14** (2006.01)

CPC (source: EP US)

**C22C 18/04** (2013.01 - EP US); **C23F 13/14** (2013.01 - EP US)

Citation (search report)

See references of WO 2009118693A1

Cited by

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